

APPLICATION DATA SHEET

APPLICATION INFORMATION

Application Type:: REGULAR
Subject Matter:: UTILITY
CD-ROM or CD-R?:: NONE
Title:: HERMETICALLY SEALED
SEMICONDUCTOR POWER MODULE
AND LARGE SCALE MODULE
COMPRISING THE SAME
Attorney Docket Number:: 248983US-2 DIV
Total Drawing Sheets:: 14

INVENTOR INFORMATION

Applicant Authority Type:: INVENTOR
Primary Citizenship Country:: Japan
Status:: FULL CAPACITY
Given Name:: Michiaki
Family Name:: HIYOSHI
City of Residence:: Tokyo
Country of Residence:: Japan
Street of Mailing Address:: c/o Intellectual Property Division
Toshiba Corporation
1-1-1, Shibaura
City of Mailing Address:: Minato-ku
State or Province of Mailing Address:: Tokyo
Country of Mailing Address:: Japan

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 22850

REPRESENTATIVE INFORMATION

Representative Customer Number:: 22850

DOMESTIC PRIORITY INFORMATION

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Division of	09/917,876	07/31/01

09/917,876	Division of	09/311,055	05/14/99
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FOREIGN PRIORITY INFORMATION

Application Number:	Country::	Filing Date::	Priority Claimed::
10-133714	Japan	05/15/98	YES

ASSIGNMENT INFORMATION

Assignee Name:: KABUSHIKI KAISHA TOSHIBA
Street of Mailing Address:: 1-1 Shibaura, 1 chome
City of Mailing Address:: Minato-ku
State or Province of Mailing Address:: Tokyo
Country of Mailing Address:: Japan